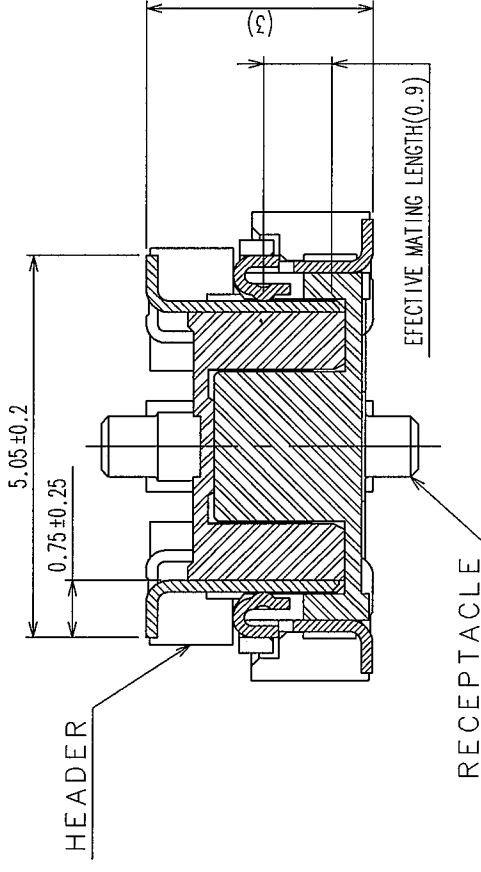
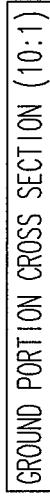
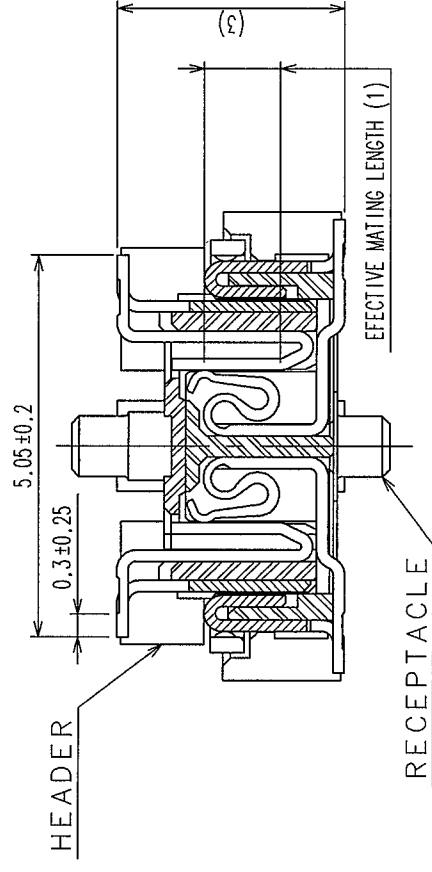
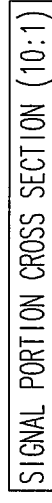
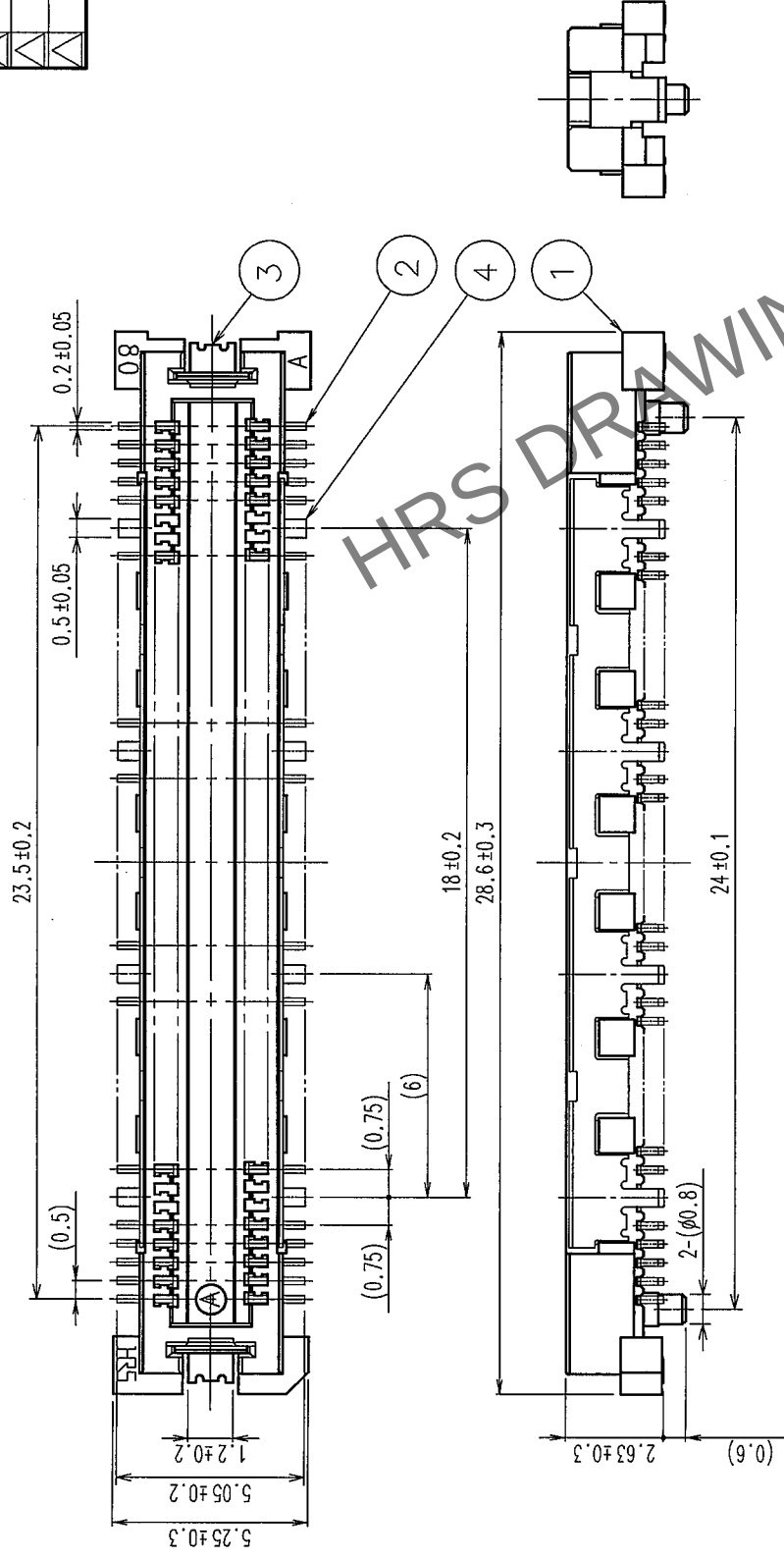
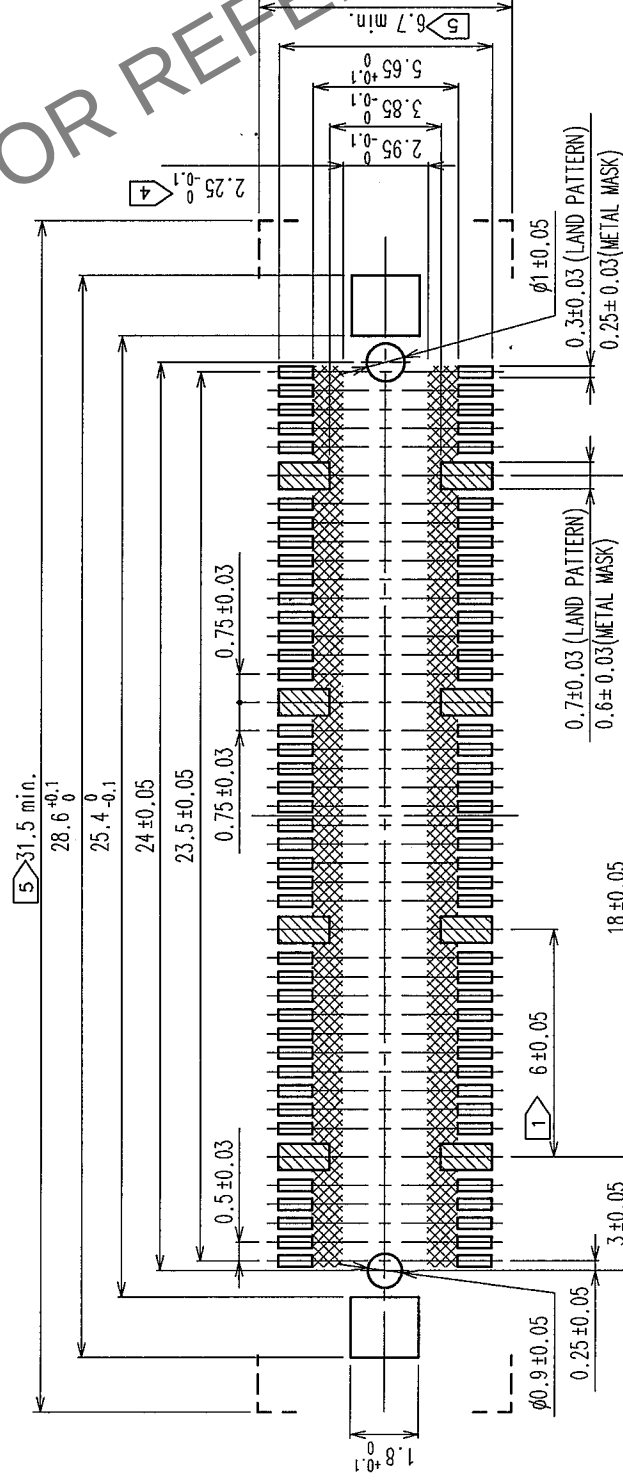


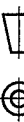
	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
	△					△				
	△				•	△				•
	△				•	△				•
	△				•	△				•



RECOMMENDED LAND PATTERN DIMENSION OF PCB



- NOTES
- 1  8 HATCHED  PARTS: GROUND CIRCUIT.
 - 2 SMT LEAD-COPLANARITY: 0.1 MAX.
 - 3 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - 4  MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED  AREA.)
 - 5  DO NOT MOUNT OTHER DEVICES INSIDE  AREA, OR MATING PAIR CANNOT BE MATED.
 - 6 DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

3, 4		PHOSPHOR BRONZE	TIN PLATING		2		COPPER ALLOY		CONTACT AREA: GOLD 0.1mmmin.	
1	LCP	BEIGE	UL94V-0	MOUNTING AREA: GOLD FLASH						
NO.	MATERIAL	FINISH, REMARKS		NO.	MATERIAL	FINISH, REMARKS		UNDER PLATING: NICKEL 1mmmin.		
CODE NO. (OLD)		DRAWN		DESIGNED		CHECKED	APPROVED	RELEASED		
CL				T. NODA		K. Ogawa		H. Kawa		
				'05.09.22		'05.09.22		'05.09.26		
		DRAWING NO.		PART NO.		FX11A-80P/8-SV0.5(71)				
		EDC3-152615-25								
SCALE		5 : 1		HIROSE ELECTRIC CO., LTD.		CODE NO.		CL573-0603-7-71		
UNITS		mm		HRS				1/1		